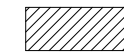
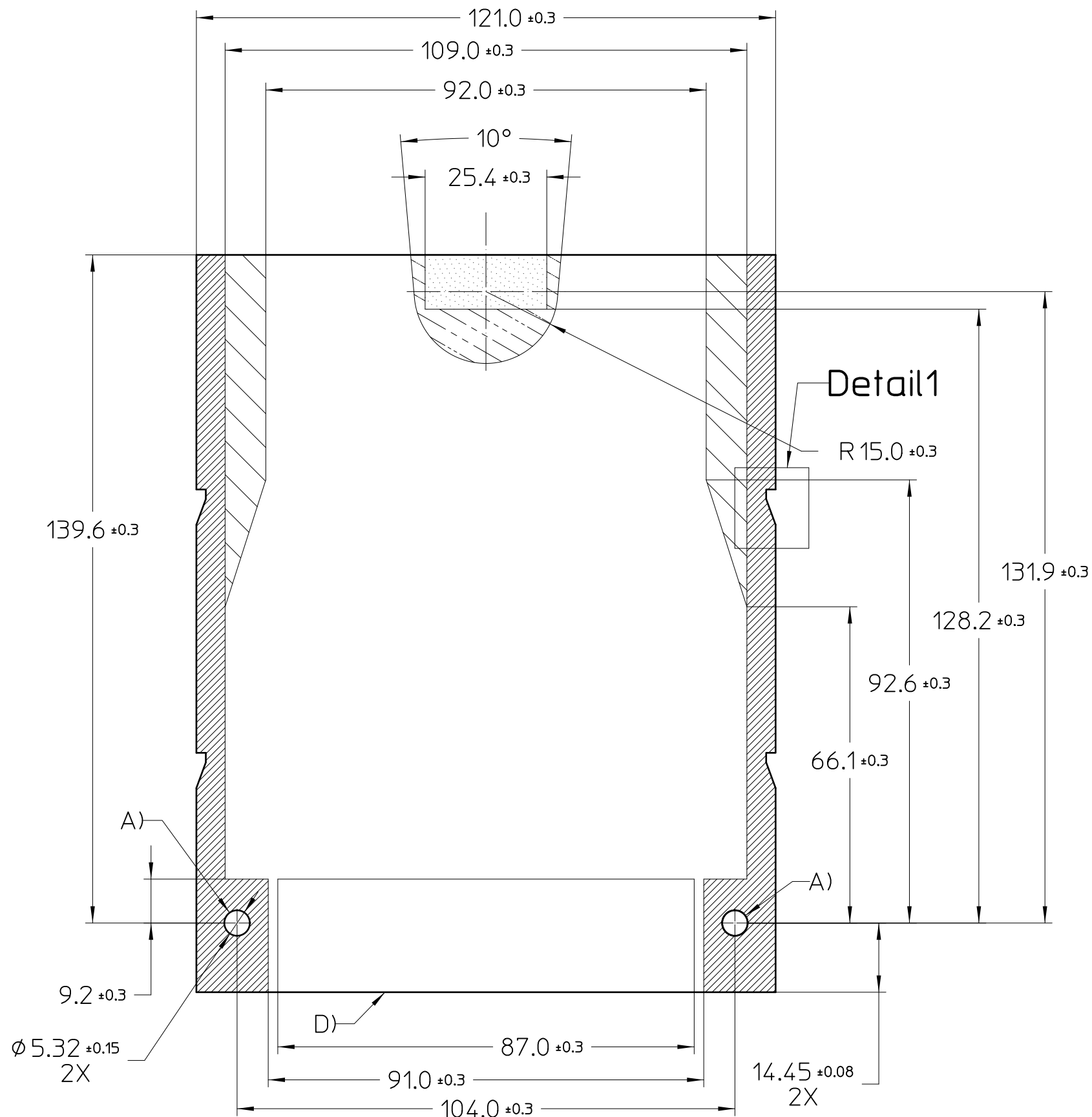
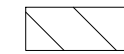


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COMPONENT / TRACE KEEP OUT ZONE



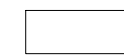
MAX COMPONENT HEIGHT ABOVE PCB = 11.5
MAX COMPONENT HEIGHT BELOW PCB = 7.5



MAX COMPONENT HEIGHT ABOVE PCB = 29.5
MAX COMPONENT HEIGHT BELOW PCB = 3.5



MAX COMPONENT HEIGHT ABOVE PCB = 29.5
MAX COMPONENT HEIGHT BELOW PCB = NO TRACE / COMPONENTS



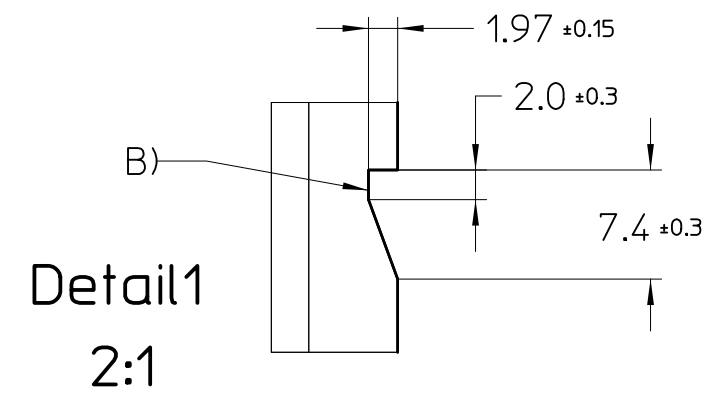
MAX COMPONENT HEIGHT ABOVE PCB = 28.5
MAX COMPONENT HEIGHT BELOW PCB = 9.5

GENERAL INFORMATION

- SIMPLIFIED REPRESENTATION
- DOCUMENT EXCLUDED FROM CHANGE PROCESS
- LINEAR DIMENSIONS (MM)
- WEB: WWW.PHOENIXCONTACT.COM WEBCODE: #0857

ADDITIONAL INFORMATION:

- A) PCB MOUNTING HARDWARE HOLE
- B) OPTIONAL CUTOUT FOR ECS-BL (LOCATION & QUANTITY BY CUSTOMER)
- C) PCB THICKNESS = 2.36 MM (.093")
- D) AREA FOR FACEPLATE PCB CONNECTIONS



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